

# Welcome to O-leading

O-Leading strives to be your one stop solution partner in EMS supply chain, including PCB design , PCB fabrication and PCB assembly (PCBA),We provide some of the most advanced PCB technology, including HDI PCBs,multilayer PCBs, Rigid-Flexible PCBs.We can support from quick turn prototype to medium & mass Production.

In general, our global customers are very impressed with our services:Rapid response, competitive price and quality commitment.Providing more valuable technical service and overall solution is the way O-leading forward.

Looking to the future, O-leading will concentrate on the innovation and development of electronics manufacturing technology as always, and make persistent efforts on PCB & PCBA one-stop service to provide first-class services and create more value for our customers.

PLEASE CLICK THESE FOR MORE INFORMATION [\*\*Multilayer FPC board with FR-4 stiffeners supplier\*\*](#)

## Product Description

**O-LEADING**  
To Be **Reliable**, To Be **Valuable**

**Fast delivery and top quality**  
**Rigid Flexible PCB**

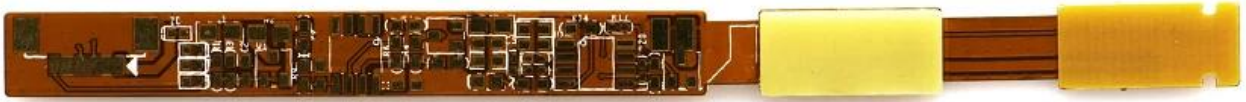


**O-LEADING**  
To Be **Reliable**, To Be **Valuable**



# O-LEADING

To Be Reliable, To Be Valuable



# O-LEADING

To Be Reliable, To Be Valuable





# Production Process

18 years experience in one-stop PCB and PCBA, we can make your idea come true,



 CONSUMER ELECTRONICS

 AUTOMOTIVE ELECTRONICS

 INDUSTRIAL CONTROL

 INTELLECTUALIZED HOUSEHOLD CONTROL

 OTHER



**30%**  
CONSUMER ELECTRONICS



**18%**  
INTELLECTUALIZED HOUSEHOLD CONTROL

**20%**  
AUTOMOTIVE ELECTRONICS



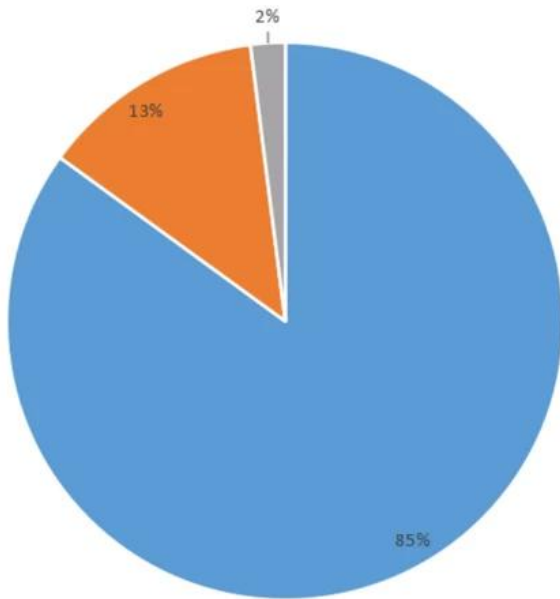
**12%**  
OTHER



**20%**  
INDUSTRIAL CONTROL



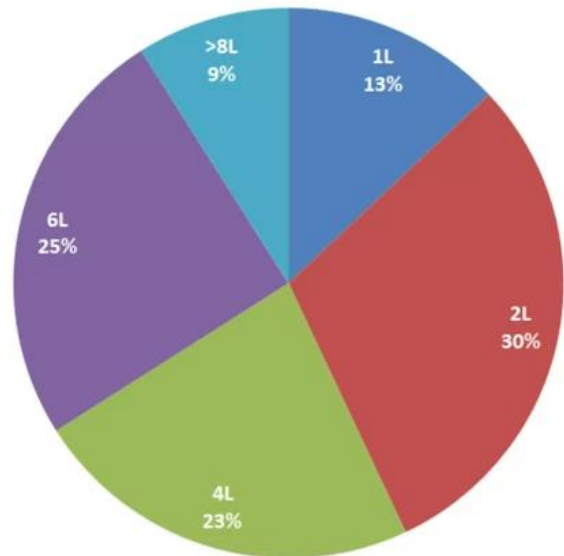
## Product types



■ FR-4 PCB ■ MC PCB ■ rigid-flexible PCB

## Product layers

■ 1L ■ 2L ■ 4L ■ 6L ■ >8L



## Our Team







Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Skyworth 创维

**HET** 和而泰  
HET INTELLIGENT CONTROL

dongweikeji  
东威科技

美的 Midea

STAR-NET  
星网锐捷

foryou  
ADAYO 华阳集团

**EDIFIER**<sup>®</sup>

Cultraview 金锐显

3nod 三诺

**T&W**

**TCL**

AcBel 康舒科技  
ACBEL POLYTECH INC.

**Honeywell**

Schneider  
Electric

**ZTE** 中兴

**EMERSON**

**BYD**

**PHILIPS**

**TE**  
connectivity

**VIDEOTON**

Certifications



**Test Report** No. SZXEC1900530401 Date: 30 Mar 2019 Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED  
1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ  
Date of Sample Received : 22 Mar 2019  
Testing Period : 22 Mar 2019 - 30 Mar 2019  
Test Requested : Selected tests(s) as requested by client.  
Test Method : Please refer to next page(s).  
Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of  
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

*Tina*  
Tina Fan  
Approved Signatory

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SGS 检测有限公司 深圳分公司  
地址: 深圳市福田区中康路12号卓越世纪中心505单元 邮编: 518129 电话: 86-755-25328888 传真: 86-755-81070190 邮箱: china@sgs.com.cn



**Test Report** No. SZXEC1900530401 Date: 30 Mar 2019 Page 2 of 6

Test Results :

**Test Part Description :**

Specimen No.	SGS Sample ID	Description
SN1	SZX19-005304.001	Green'PCB'

- Remarks :
- (1) 1 mg/kg = 1 ppm = 0.0001%
  - (2) MDL = Method Detection Limit
  - (3) ND = Not Detected (< MDL)
  - (4) "-" = Not Regulated

**RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU**

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC62321-5:2013, IEC62321-7-2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	0/1
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND

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## ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

## Wiring, Printed - Component

See General Information for Wiring, Printed - Component

**O-LEADING SUPPLY CHAIN (HK) CO LTD**

E490354

ROOM 1205, 12/F  
TAI SANG BANK BLDG  
130-132 DES VOEUS ROAD  
CENTRAL, HONG KONG

Type	Cond Width		Cond Thk	SS/ DS/ DSO	Max	Max		Meets UL796	C T		
	Min	Edge			Area	Solder	Oper			Flame	
	mm(in)	mm(in)	mic(mil)		mm(in)	C	sec	C	Class	DSR	I
<b>Multilayer (mass laminate) printed wiring boards.</b>											
<b>O-LEADING-401</b>	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
<b>O-LEADING-407</b>	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
<b>Multilayer printed wiring boards.</b>											
<b>O-LEADING-408</b>	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
<b>Single layer printed wiring boards.</b>											
<b>O-LEADING-002</b>	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
<b>O-LEADING-003</b>	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
<b>O-LEADING-033</b>	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
<b>O-LEADING-205</b>	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
<b>O-LEADING-206</b>	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
<b>O-LEADING-D01</b>	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
<b>O-LEADING-S01</b>	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

## WIRING, PRINTED - COMPONENT | UL Product iQ

<b>O-LEADING-S02</b>	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
<b>O-LEADING-S03</b>	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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# Process Capability

## PCB Production Capabilities

Layer Count	1Layer-32Layer
Finished copper thickness	1/3oz-12oz
Min Line width/spacing internal	3.0mil/3.0mil
Min Line width/spacing external	4.0mil/4.0mil
Max Aspect Ratio	10:1
Board thickness	0.2mm-5.0mm
Max Panel size(inches)	635*1500mm
Minimum Drilled Hole Size	4mil
Plated Hole Tolerance	+/-3mil
Blind/Buried Vias (All Types)	YES
Via Fill(Conductive,Non-Conductive)	YES
Base Material	FR-4,FR-4high Tg,Halogen free material,Rogers,Aluminium base,Polyimide,Heavy Copper
Surface finishes	HASL,OSP,ENIG,HAL-LF,Immersion silver,Immersion Tin,Gold fingers,Carbon ink

## SMT Production Capabilities

PCB Material	FR-4,CEM-1,CEM-3,Aluminum-based board
Max PCB size	510x460mm
Min PCB size	50x50mm
PCB Thickness	0.5mm-4.5mm
Board thickness	0.5-4mm
Min Components size	0201
Standard chip size component	0603 and larger
Component max height	15mm
Min lead pitch	0.3mm
Min BGA ball pitch	0.4mm
Placement precision	+/-0.03mm

# Packaging & Delivery

# Shipping service





Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

## FAQ

### 1. How do O-Leading ensure quality?

Our high quality standard is achieved with the following.

1.1 The process is strictly controlled under ISO 9001:2008 standards.

1.2 Extensive use of software in managing the production process

1.3 State-of-art testing equipments and tools. E.g. Flying Probe, X-ray Inspection, AOI (Automated Optical Inspector) and ICT (in-circuit testing).

1.4.Dedicated quality assurance team with failure case analysis process

1.5.Continuous staff training and education

### 2. How do O-Leading keep your price competitive?

Over the last decade, prices of many raw materials (e.g. copper, chemicals) had doubled, tripled or quadrupled; Chinese currency RMB had appreciated 31% over US dollar; And our labor cost also increased significantly.

However, O-Leading have kept our pricing steady. This owns entirely to our innovations in reducing cost, avoiding wastes and improving efficiency. Our prices are very competitive in the industry at the same quality level.

We believe in a win-win partnership with our customers. Our partnership will be mutually beneficial if we can provide you an edgeon cost and quality.

### **3. What kinds of boards can O-Leading process?**

Common FR4, high-TG and halogen-free boards, Rogers, Arlon, Telfon, aluminum/copper-based boards, PI, etc.

### **4. What data are needed for PCB & PCBA production?**

4.1 BOM (Bill of Materials) with reference designators: component description, manufacturer's name and part number.

4.2 PCB Gerber files.

4.3 PCB fabrication drawing and PCBA assembly drawing.

4.4 Test procedures.

4.5 Any mechanical restrictions such as assembly height requirements.

### **5. What's the typical process flow for multi-layer PCB?**

Material cutting → Inner dry film → inner etching → Inner AOI → Multi-bond → Layer stack up Pressing → Drilling → PTH → Panel Plating → Outer Dry Film → Pattern Plating → Outer etching → Outer AOI → Solder Mask → Component Mark → Surface finish → Routing → E/T → Visual Inspection.

### **6. What's the key equipments for HDI manufacturing?**

Key equipment list is as following: Laser drilling machine, Pressing machine, VCP line, Automatic Exposing machine, LDI and etc.

The equipments we have are the best in the industry, laser drilling machines are from Mitsubishi and Hitachi, LDI machines are from Screen(Japan), Automatic Exposing machines are also from Hitachi, all of them make we can meet customer's technical requirements.

### **7. How many types of surface finish O-lead can do?**

O-the leader has the full series of surface finish, such as: ENIG, OSP, LF-HASL, gold plating (soft/hard), immersion silver, Tin, silver plating, immersion tin plating, carbon ink and etc. .. OSP, ENIG, OSP + ENIG commonly used on the HDI, we usually recommend that you use a client or OSP OSP + ENIG if BGA PAD size less than 0.3 mm.

### **8. What's your capability for FPC? Can O-Leading provide SMT service also?**

O-Leading can fabricate FPC from single layer to 8layer, the working panel size can be as large as 2000mm\*240mm, please find the details in the page "Flex Capability"

We also provide SMT one stop service to customer.

### **9. What are the main factors which will affect the price of PCB?**

Material;

Surface finish;

Technology difficulty;

Different quality criteria;

PCB characteristics;

Payment terms;

Different manufacturing countries.

### **10. What's the definition of PCB, PWB and FPC and what's the difference?**

PCB is short for Printed Circuit Board;

PWB is short for Printed Wire Board, same meaning as Printed Circuit Board;

FPC is short for Flexible Printed Board.

### **11. What factors should be considered when choosing the material for a PCB board?**

Below factors should be considered when we choose the material for PCB:

The material's Tg value should be greater than the operation temperature;

Low CTE material has good performance of thermal stability;

Good thermal resistance performance: Normally PCBs are required to resist 250°C for at least 50s.  
Good flatness; In consideration of the electrical properties, low loss/high permittivity material is used on high frequency PCB; Polyimide glass fiber substrate used for flexible PCB; Metal core is used when the product has strict requirement of heat dissipation.

### **12. What's the merits of O-leading's rigid-flex PCB?**

O-leading's rigid-flex PCB has the characters of both FPC and PCB, so it can be used in some special products. Some part is flexible while the other part rigid, it can help save product's interior space, reduce product volume and improve performance.

### **13. How to you make the impedance calculation?**

The impedance control system is done using some test coupons, the SI6000 soft and the CITS 500s equipment from POLAR INSTRUMENTS.

The equipment measures the impedance on a representative track configuration coupon of which the client has given us a determinate value and tolerance.